

10Mbit/s High Speed Logic Gate Photo Coupler**Description**

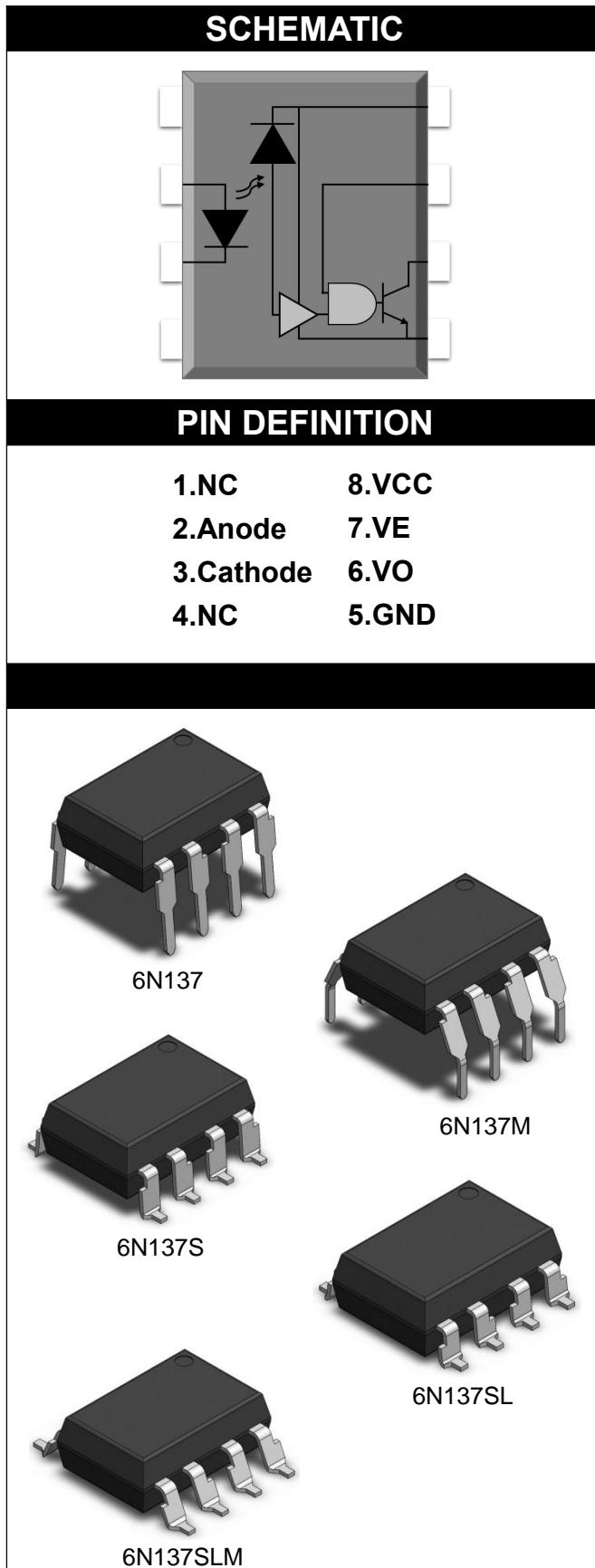
The 6N137, SL2601, SL2611 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon high speed integrated photo-detector logic gate with a strobable output in a plastic DIP8 package with different lead forming options.

Features

- High isolation 5000 VRMS
- DC input with logic gate output
- Operating temperature range - 55 °C to 100 °C
- REACH compliance
- Halogen free (Optional)
- MSL class 1
- Regulatory Approvals (Pending Approved)
 - UL - UL1577
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC - GB4943.1, GB8898
 - cUL- CSA Component Acceptance Service Notice No. 5A

Applications

- Ground loop elimination
- LSTTL to TTL, LSTTL or CMOS
- Line receiver, data transmission
- Data multiplexing
- Switching power supply
- Pulse transformer replacement
- Computer-peripheral interface



ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	VALUE	UNIT	Note
INPUT				
Forward Current	I _F	25	mA	
Peak Forward Current	I _{FP}	50	mA	1
Peak Transient Current	I _{F(trans)}	1	A	2
Reverse Voltage	V _R	5	V	
Enable Voltage	V _E	VCC+0.5	V	
Input Power Dissipation	P _I	100	mW	
OUTPUT				
Supply Voltage	V _{CC}	7	V	
Output Voltage	V _O	7	V	
Output Current	I _O	50	mA	
Output Power Dissipation	P _O	85	mW	
COMMON				
Total Power Dissipation	P _{tot}	200	mW	
Isolation Voltage	V _{iso}	5000	Vrms	3
Operating Temperature	T _{opr}	-55~100	°C	
Storage Temperature	T _{stg}	-55~125	°C	
Soldering Temperature	T _{sol}	260	°C	4

Note 1. 50% duty, 1ms P.W

Note 2. $\leq 1\mu s$ P.W,300pps

Note 3. AC For 1 Minute, R.H. = 40 ~ 60%

Note 4. For 10 seconds

RECOMMENDED OPERATION CONDITIONS					
PARAMETER		SYMBOL		MIN.	MAX.
Operating Temperature		TA		-40	100
Supply Voltage		VCC		2.7	3.6
		VCC		4.5	5.5
Low Level Input Current		IFL		0	250
High Level Input Current		IFH		5	15
Low Level Enable Voltage		VEL		0	0.8
High Level Enable Voltage		VEH		2	VCC
Output Pull-up Resistor		RL		330	4k
Fan Out (at RL=1kΩ per channel)		N		-	5
				TTL Loads	

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
INPUT						
Forward Voltage	V _F	-	1.38	1.8	V	I _F =10mA
Reverse Current	I _R	-	-	10	µA	V _R =5V
Input Capacitance	C _{in}	-	13	-	pF	V=0, f=1MHz
OUTPUT						
High Level Supply Current	I _{CCH}	-	6.3	10	mA	I _F =0mA, V _E =0.5V, V _{CC} =5.5V
Low Level Supply Current	I _{CCL}	-	8.3	13	mA	I _F =10mA, V _{CC} =5.5V
High Level Enable Current	I _{EH}	-	-0.52	-1.6	mA	V _E =2.0V, V _{CC} =5.5V
Low Level Enable Current	I _{EL}	-	-0.75	-1.6	mA	V _E =0.5V, V _{CC} =5.5V
High Level Enable Voltage	V _{EH}	2.0	-	-	V	I _F =10mA, V _{CC} =5.5V
Low Level Enable Voltage	V _{EL}	-	-	0.8	V	I _F =10mA, V _{CC} =5.5V
TRANSFER CHARACTERISTICS (Ta=-40 to 85°C)						
High Level Output Current	I _{OH}	-	0.73	100	µA	V _{CC} =5.5V, V _O =5.5V, I _F =250µA, V _E =2.0V
Low Level Output Voltage	V _{OL}	-	0.28	0.6	V	V _{CC} =5.5V, I _F =5mA, V _E =2.0V, I _{CL} =13mA
Input Threshold Current	I _{IT}	-	2.5	5	mA	V _{CC} =5.5V, V _O =0.6V, V _E =2.0V, I _{OL} =13mA
Isolation Resistance	R _{iso}	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.
Floating Capacitance	C _{IO}	-	1.0	-	pF	V=0, f=1MHz

ELECTRICAL OPTICAL CHARACTERISTICS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
SWITCHING CHARACTERISTICS (Ta=-40 to 85°C, V _{CC} =5V, I _F =7.5mA unless specified otherwise)							
Propagation Delay Time to Output Low Level	TPHL	-	35	75	ns	C _L =15pF, R _L =350Ω, Ta=25°C	
Propagation Delay Time to Output High Level	TPLH	-	40	75	ns	C _L =15pF, R _L =350Ω, Ta=25°C	
Pulse Width Distortion	TPHL-TPLH	-	5	35	ns	C _L =15pF, R _L =350Ω	
Rise Time	tr	-	27	-	ns	C _L =15pF, R _L =350Ω	
Fall Time	tf	-	7	-	ns	C _L =15pF, R _L =350Ω	
Enable Propagation Delay Time to Output Low Level	TEHL	-	15	-	ns	I _F =7.5mA, V _{EH} =3.5V, C _L =15pF, R _L =350Ω	
Enable Propagation Delay Time to Output High Level	TELH	-	15	-	ns	I _F =7.5mA, V _{EH} =3.5V, C _L =15pF, R _L =350Ω	
Common Mode Transient Immunity at Logic High	6N137	CMH	-	-	-	I _F = 7.5mA , V _{OH} =2.0V, R _L =350Ω, Ta=25°C V _{CM} =10Vp-p	
	SL2601		5000	-	-		
	SL2611		10000	-	-		
Common Mode Transient Immunity at Logic Low	6N137	CML	-	-	-	I _F = 0mA , V _{OH} =0.8V, R _L =350Ω, Ta=25°C V _{CM} =10Vp-p	
	SL2601		5000	-	-		
	SL2611		10000	-	-		

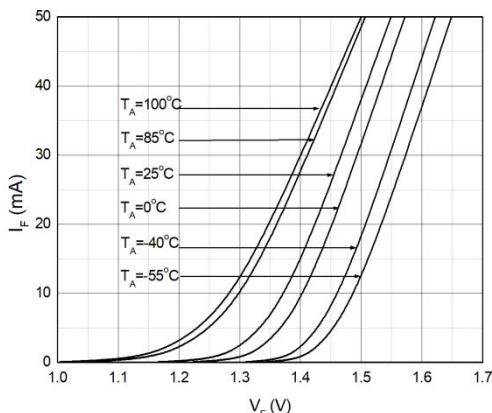
ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V _F	-	1.38	1.8	V	I _F =10mA	
Reverse Current	I _R	-	-	10	μA	V _R =5V	
Input Capacitance	C _{in}	-	13	-	pF	V=0, f=1MHz	
OUTPUT							
High Level Supply Current	I _{CCH}	-	4.3	10	mA	I _F =0mA, V _E =0.5V, V _{CC} =3.3V	
Low Level Supply Current	I _{CCL}	-	6.4	13	mA	I _F =10mA, V _{CC} =3.3V	
High Level Enable Current	I _{EH}	-	-0.21	-1.6	mA	V _E =2.0V, V _{CC} =3.3V	
Low Level Enable Current	I _{EL}	-	-0.42	-1.6	mA	V _E =0.5V, V _{CC} =3.3V	
High Level Enable Voltage	V _{EH}	2.0	-	-	V	I _F =10mA, V _{CC} =3.3V	
Low Level Enable Voltage	V _{EL}	-	-	0.8	V	I _F =10mA, V _{CC} =3.3V	
TRANSFER CHARACTERISTICS (Ta=-40 to 85°C)							
High Level Output Current	I _{OH}	-	4.1	100	μA	V _{CC} =3.3V, V _O =3.3V, I _F =250μA, V _E =2.0V	
Low Level Output Voltage	V _{OL}	-	0.29	0.6	V	V _{CC} =3.3V, I _F =5mA, V _E =2.0V, I _{CL} =13mA	
Input Threshold Current	I _{FT}	-	2.2	5	mA	V _{CC} =3.3V, V _O =0.6V, V _E =2.0V, I _{OL} =13mA	
Isolation Resistance	R _{iso}	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C _{IO}	-	1.0	-	pF	V=0, f=1MHz	

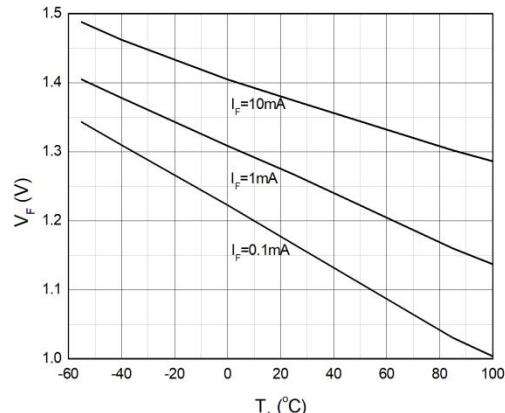
ELECTRICAL OPTICAL CHARACTERISTICS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
SWITCHING CHARACTERISTICS ($T_a = -40$ to $85^\circ C$, $V_{CC} = 3.3V$, $I_F = 7.5mA$ unless specified otherwise)							
Propagation Delay Time to Output Low Level	TPHL	-	35	75	ns	$C_L = 15pF$, $R_L = 350\Omega$, $T_a = 25^\circ C$	
Propagation Delay Time to Output High Level	TPLH	-	47	75	ns	$C_L = 15pF$, $R_L = 350\Omega$, $T_a = 25^\circ C$	
Pulse Width Distortion	TPHL-TPLH	-	12	35	ns	$C_L = 15pF$, $R_L = 350\Omega$	
Rise Time	tr	-	30	-	ns	$C_L = 15pF$, $R_L = 350\Omega$	
Fall Time	tf	-	8.5	-	ns	$C_L = 15pF$, $R_L = 350\Omega$	
Enable Propagation Delay Time to Output Low Level	TEHL	-	15	-	ns	$I_F = 7.5mA$, $V_{EH} = 3.3.3V$, $C_L = 15pF$, $R_L = 350\Omega$	
Enable Propagation Delay Time to Output High Level	TELH	-	15	-	ns	$I_F = 7.5mA$, $V_{EH} = 3.3.3V$, $C_L = 15pF$, $R_L = 350\Omega$	
Common Mode Transient Immunity at Logic High	6N137	CMH	-	-	-	$I_F = 7.5mA$, $V_{OH} = 2.0V$, $R_L = 350\Omega$, $T_a = 25^\circ C$ $V_{CM} = 10Vp-p$	
	SL2601		5000	-	-		
	SL2611		10000	-	-		
Common Mode Transient Immunity at Logic Low	6N137	CML	-	-	-	$I_F = 0mA$, $V_{OH} = 0.8V$, $R_L = 350\Omega$, $T_a = 25^\circ C$ $V_{CM} = 10Vp-p$	
	SL2601		5000	-	-		
	SL2611		10000	-	-		

CHARACTERISTIC CURVES

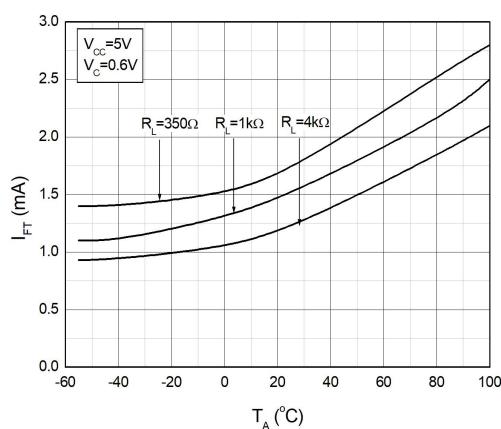
**Fig.1 Forward Current
vs. Forward Voltage**



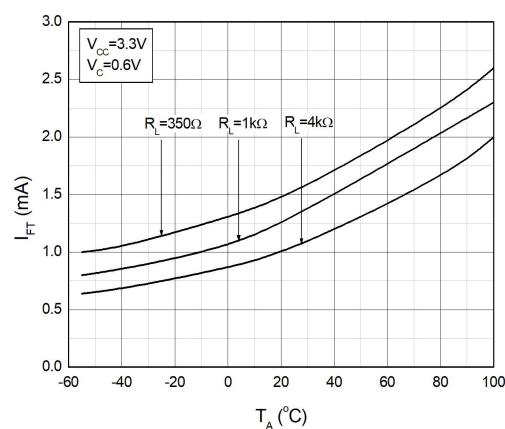
**Fig.2 Forward Voltage
vs. Ambient Temperature**



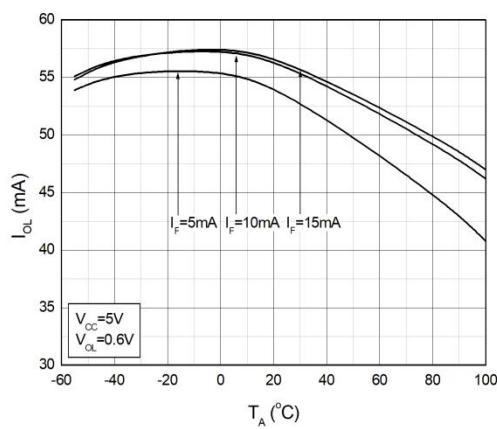
**Fig.3 Input Threshold Current
vs. Ambient Temperature**



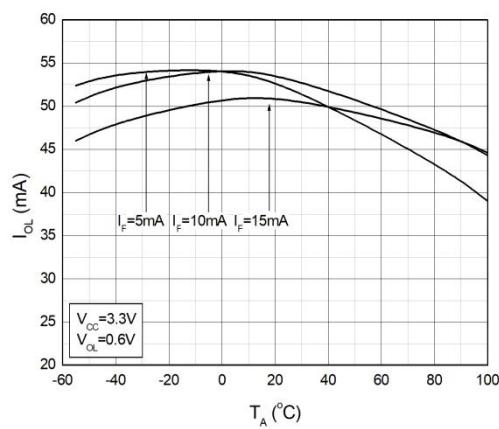
**Fig.4 Input Threshold Current
vs. Ambient Temperature**



**Fig.5 Low Level Output Current
vs. Ambient Temperature**



**Fig.6 Low Level Output Current
vs. Ambient Temperature**



CHARACTERISTIC CURVES

Fig.7 Low Level Output Voltage vs. Ambient Temperature

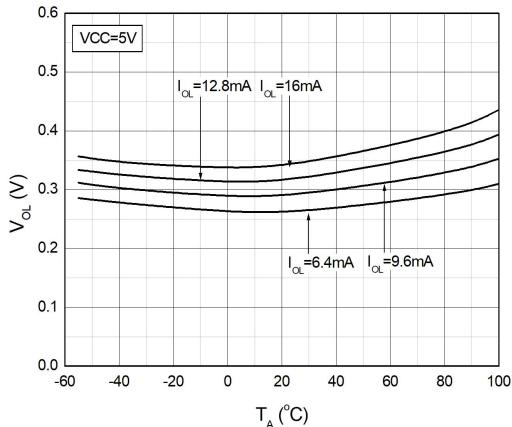


Fig.8 Low Level Output Voltage vs. Ambient Temperature

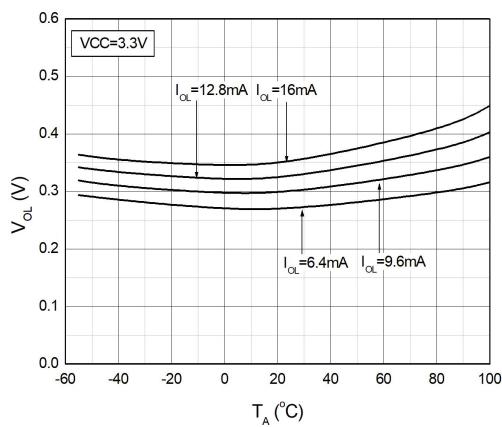


Fig.9 High Level Output Current vs. Ambient Temperature

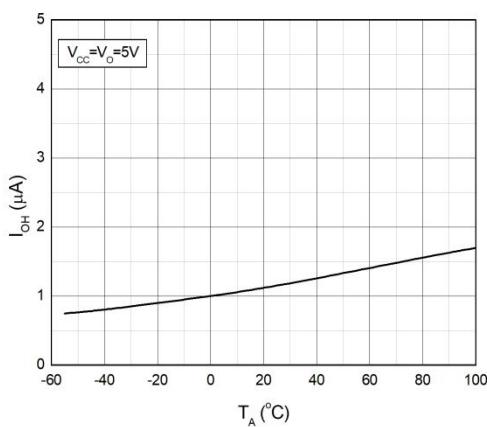


Fig.10 High Level Output Current vs. Ambient Temperature

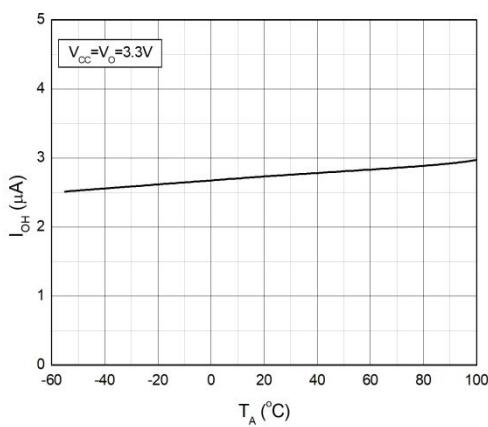


Fig.11 Output Voltage vs. Forward Current

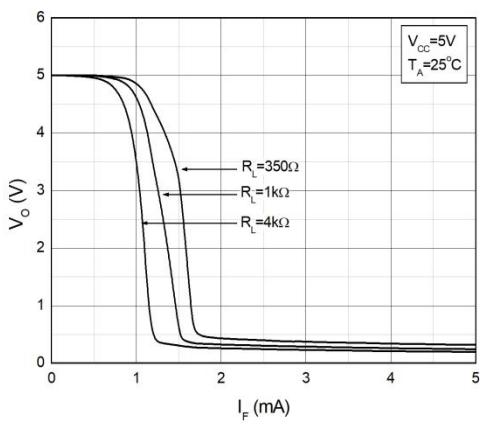
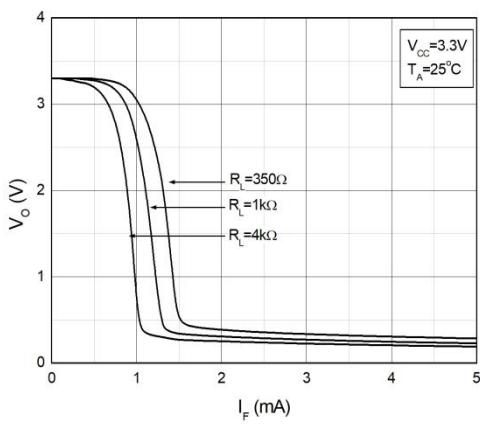
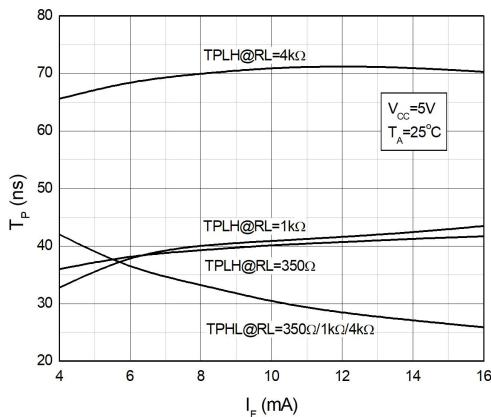


Fig.12 Output Voltage vs. Forward Current

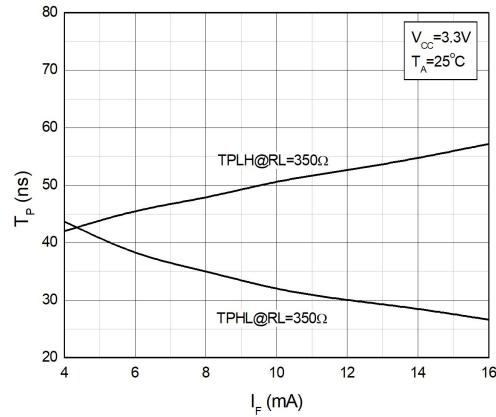


CHARACTERISTIC CURVES

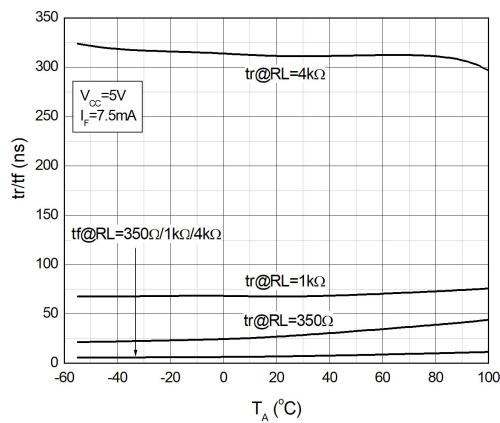
**Fig.13 Propagation Delay
vs. Forward Current**



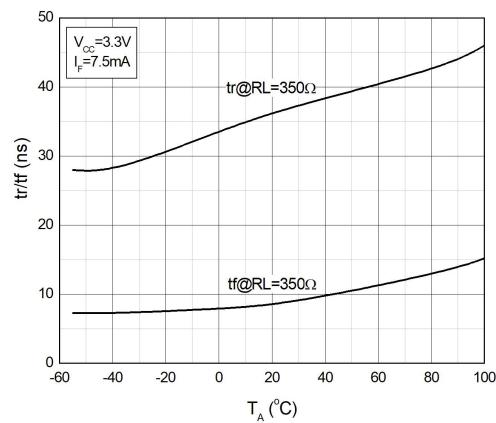
**Fig.14 Propagation Delay
vs. Forward Current**



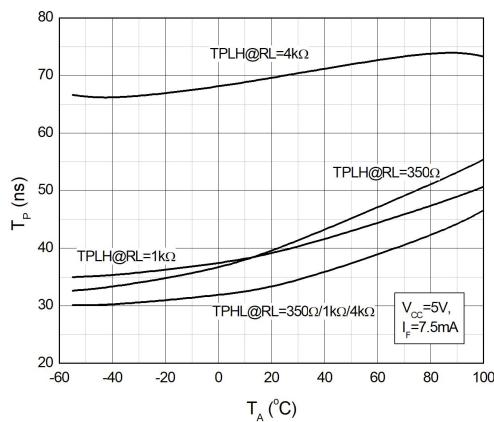
**Fig.15 Rise and Fall Time
vs. Ambient Temperature**



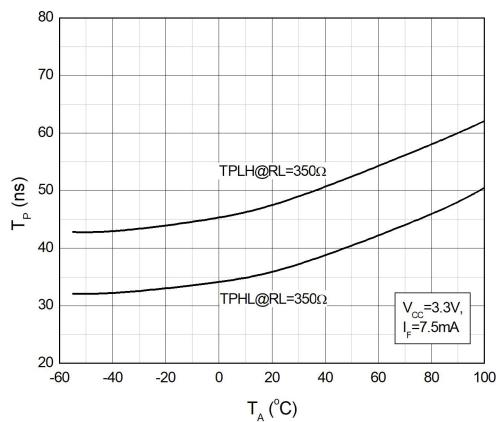
**Fig.16 Rise and Fall Time
vs. Ambient Temperature**



**Fig.17 Propagation Delay
vs. Ambient Temperature**

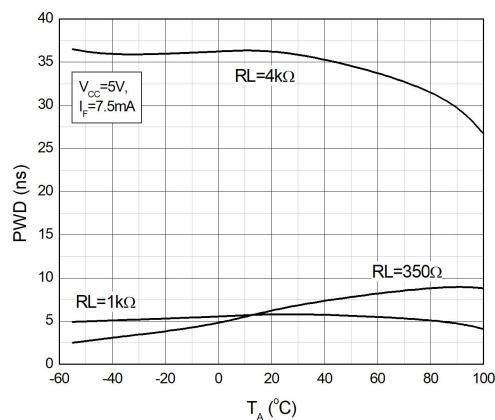


**Fig.18 Propagation Delay
vs. Ambient Temperature**

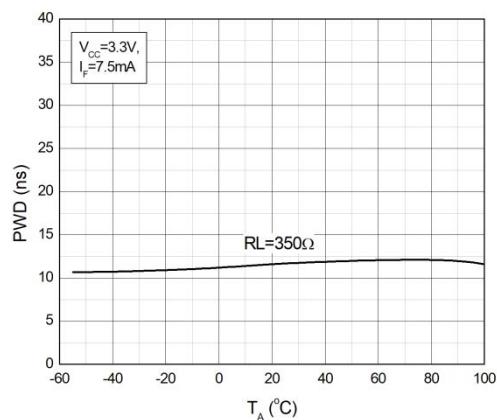


CHARACTERISTIC CURVES

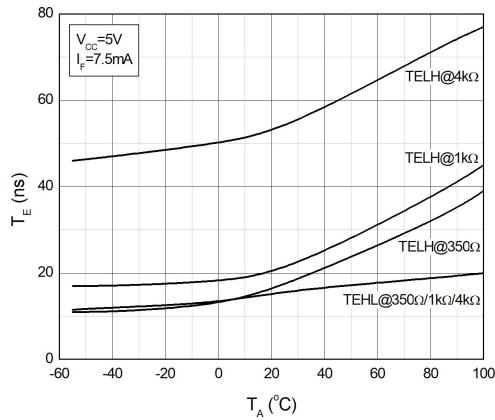
**Fig.19 Pulse Width Distortion
vs. Ambient Temperature**



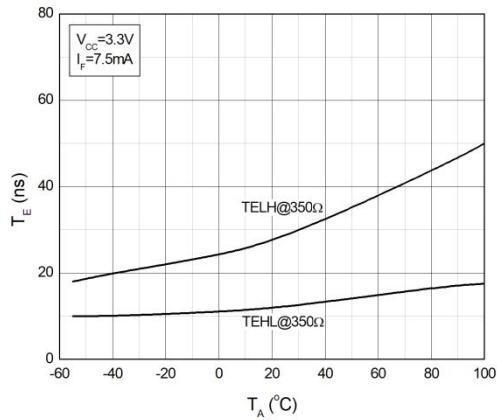
**Fig.20 Pulse Width Distortion
vs. Ambient Temperature**

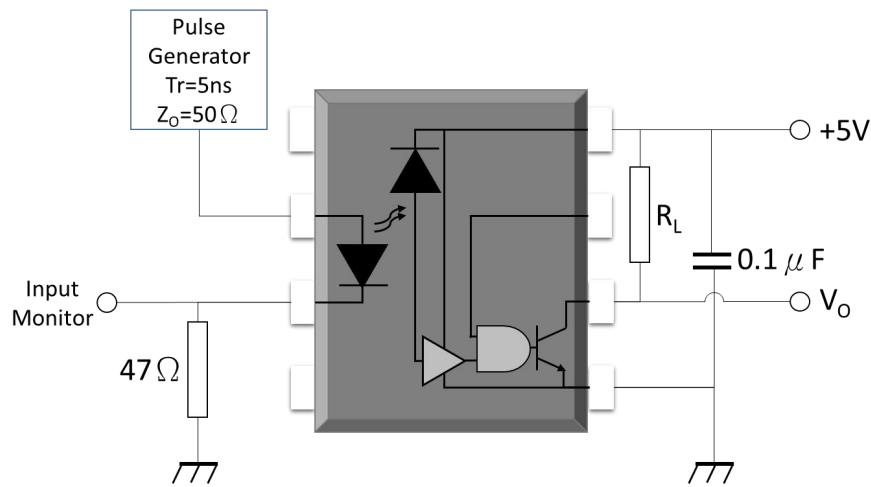
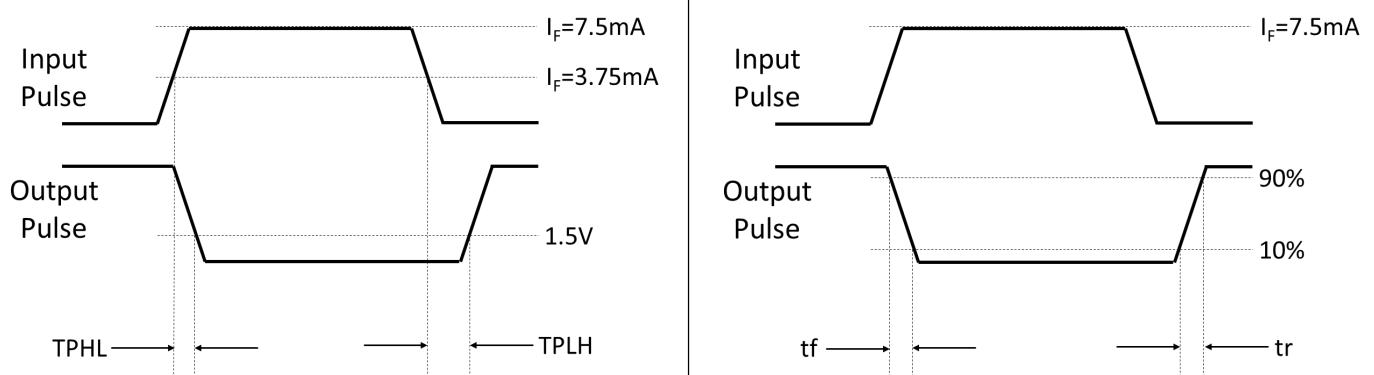


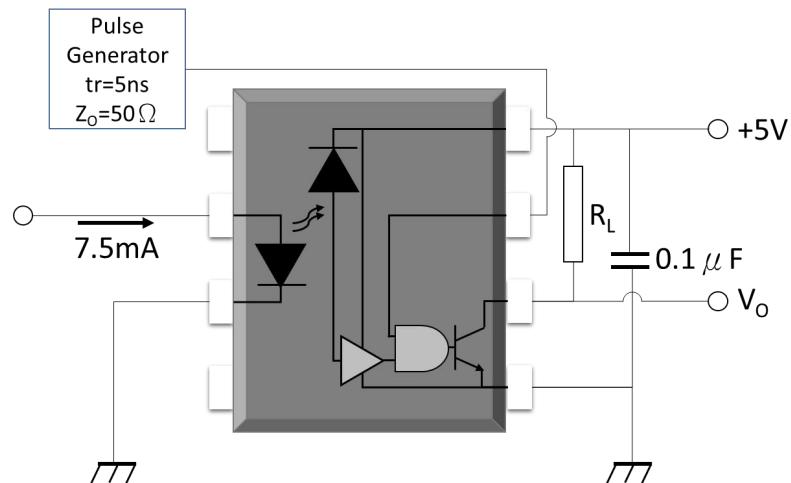
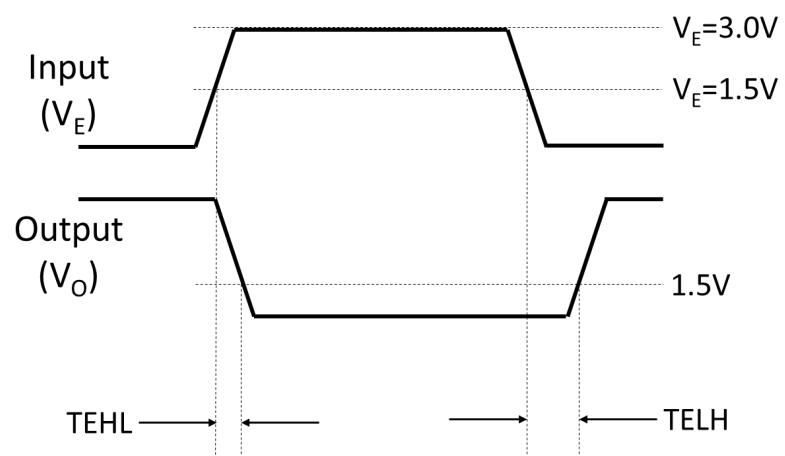
**Fig.21 Enable Propagation Delay
vs. Ambient Temperature**

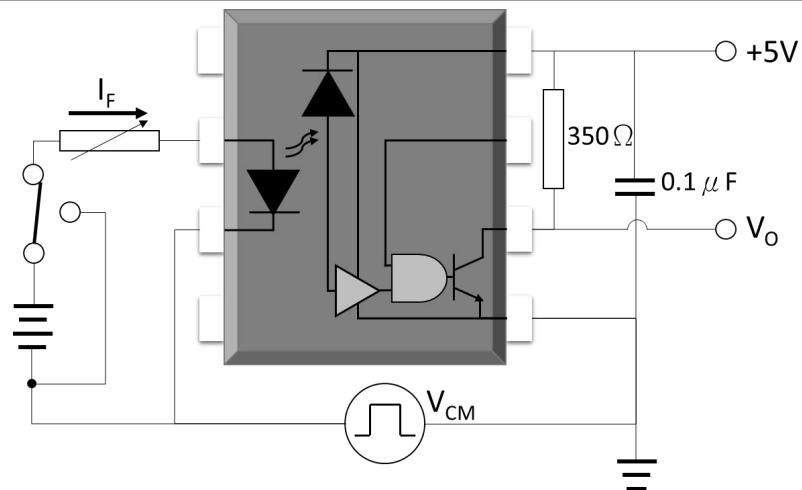
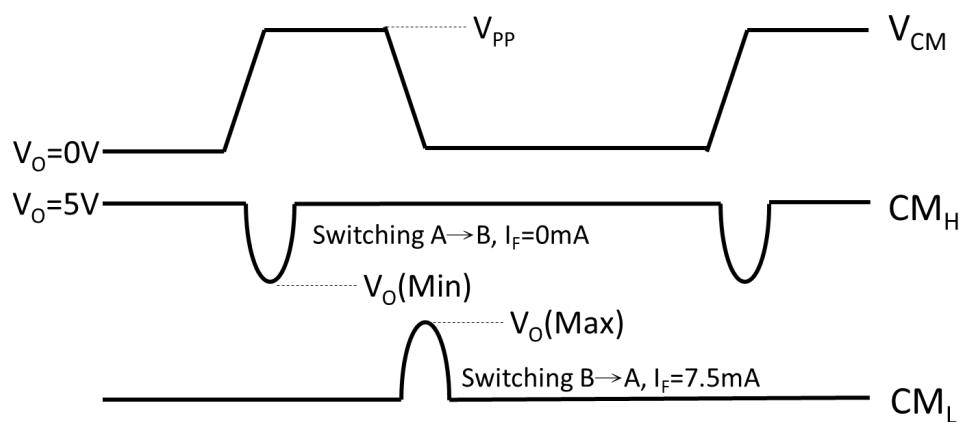


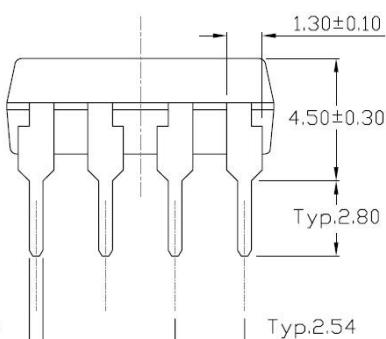
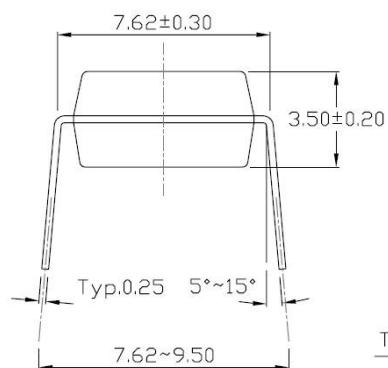
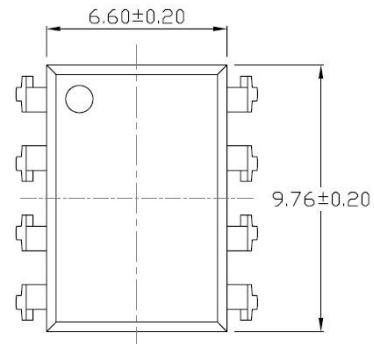
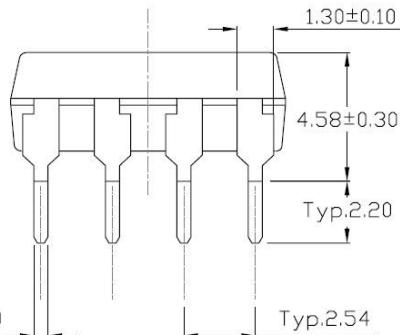
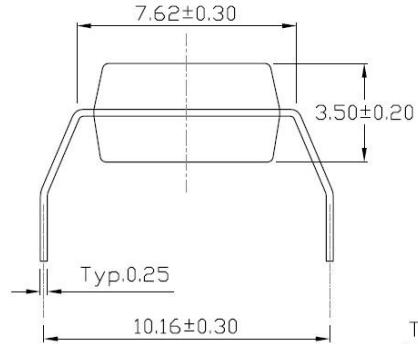
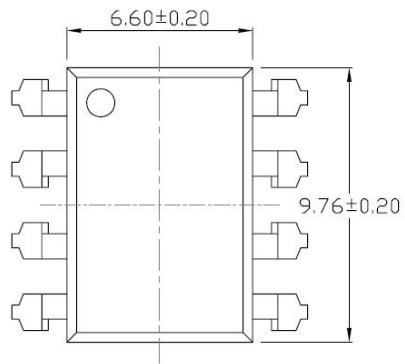
**Fig.22 Enable Propagation Delay
vs. Ambient Temperature**



TEST CIRCUITS**Fig.23 Test Circuits for TPHL, TPLH, tr, tf****Fig.24 Waveforms of TPHL, TPLH, tr, tf**

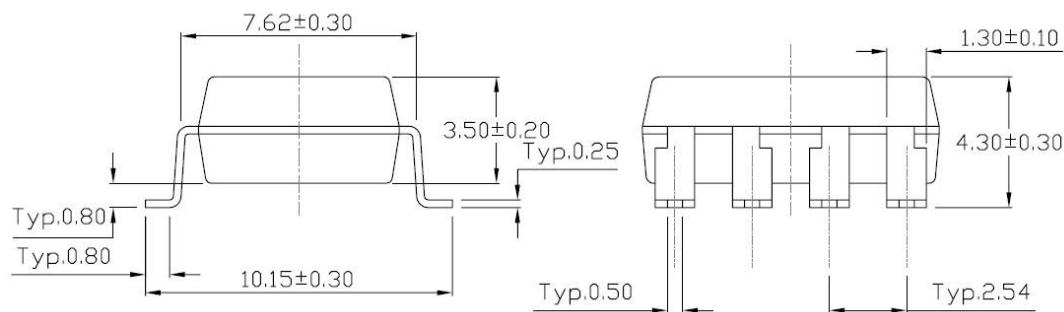
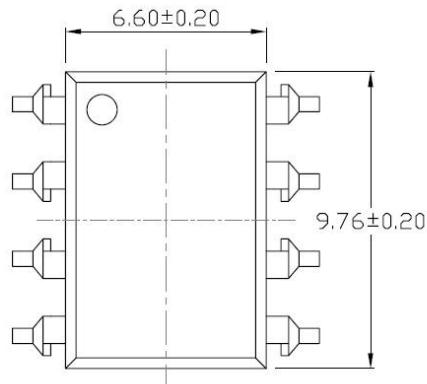
TEST CIRCUITS**Fig.25 Test Circuits for TEHL, TELH****Fig.26 Waveforms of TEHL, TELH**

TEST CIRCUITS**Fig.25 Test Circuits for Common Mode Transient Immunity****Fig.26 Waveforms of Common Mode Transient Immunity**

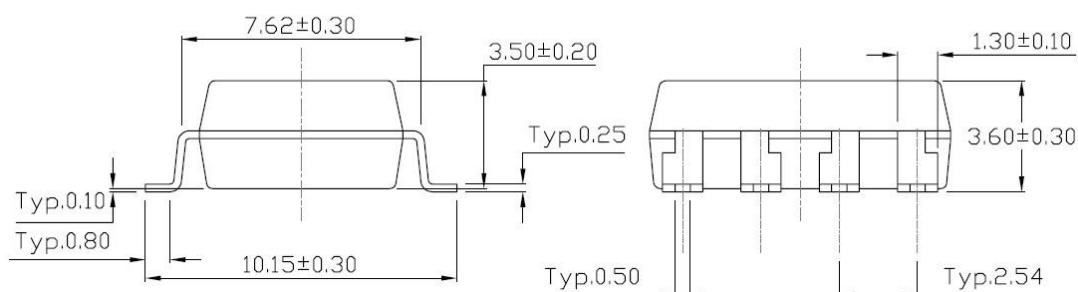
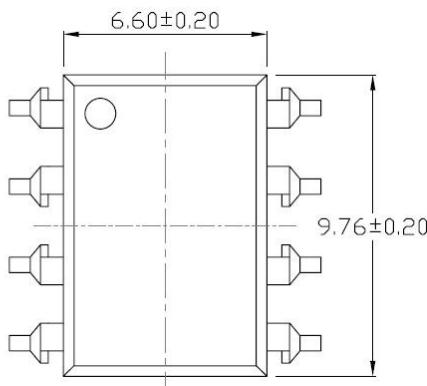
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)**Standard DIP – Through Hole (DIP Type)****Gullwing (400mil) Lead Forming – Through Hole (M Type)**

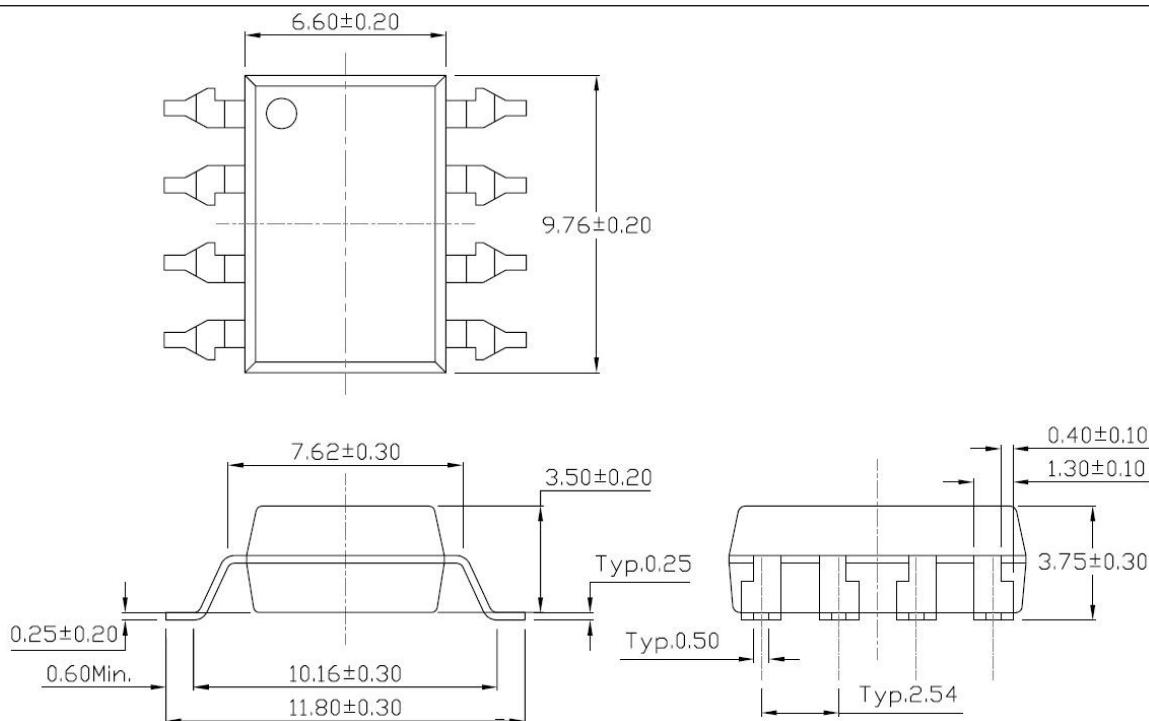
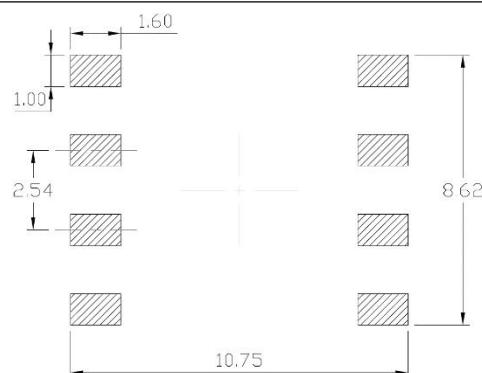
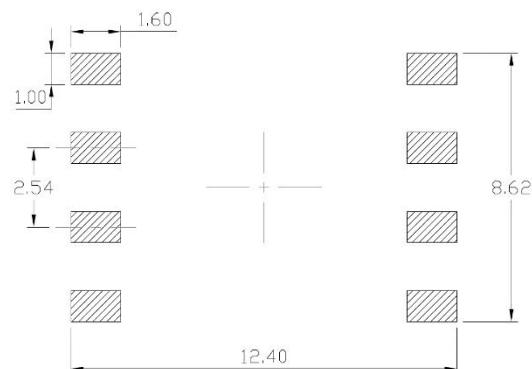
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

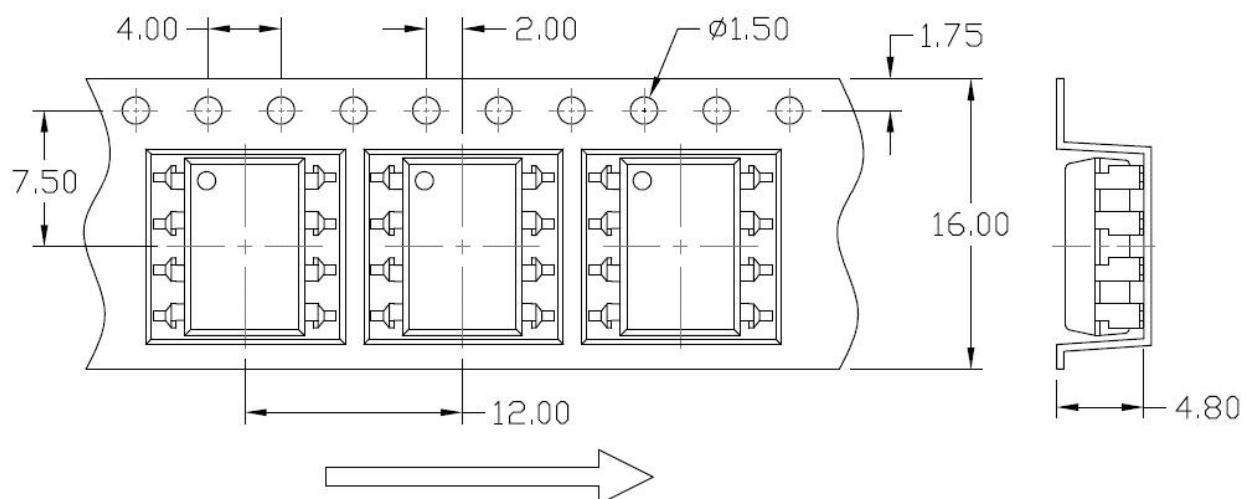
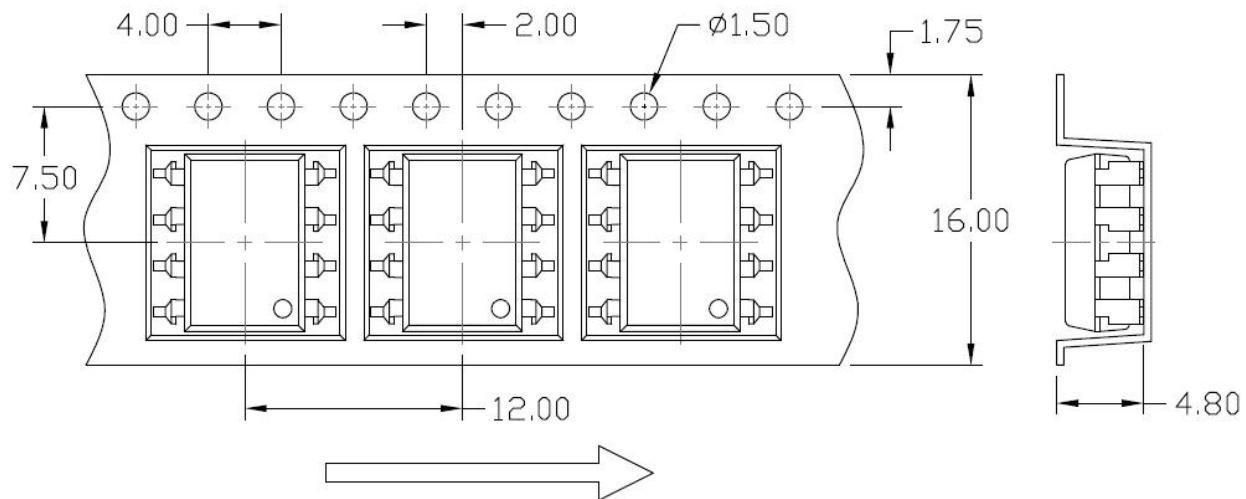
Surface Mount Lead Forming (S Type)



Surface Mount (Low Profile) Lead Forming (SL Type)

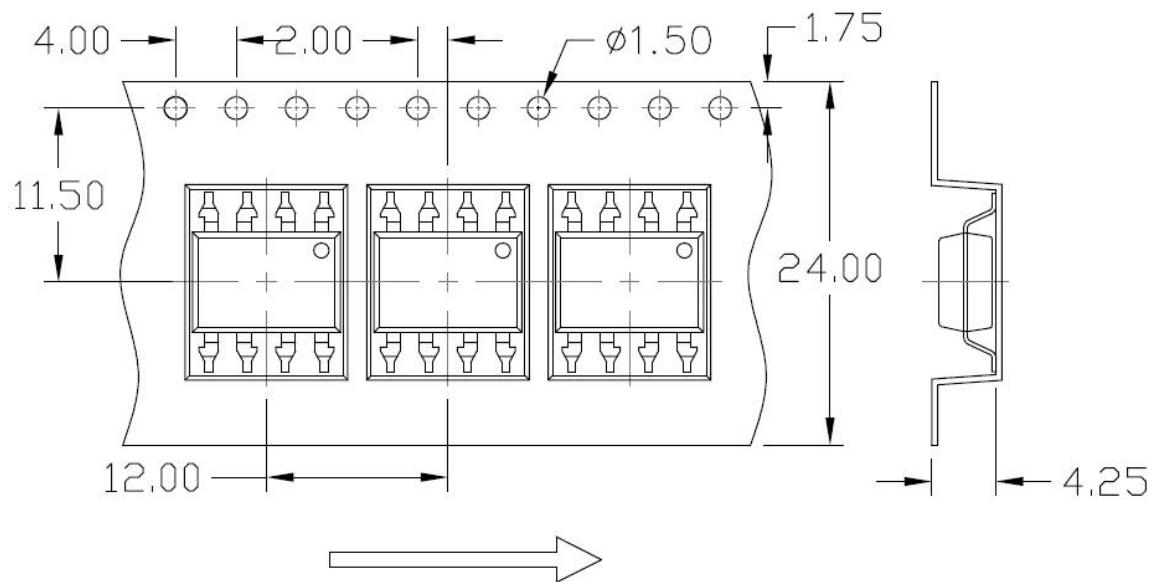


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)**Surface Mount (Gullwing) Lead Forming (SLM Type)****Recommended Solder Mask** (Dimensions in mm unless otherwise stated)**Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming****Surface Mount (Gullwing) Lead Forming**

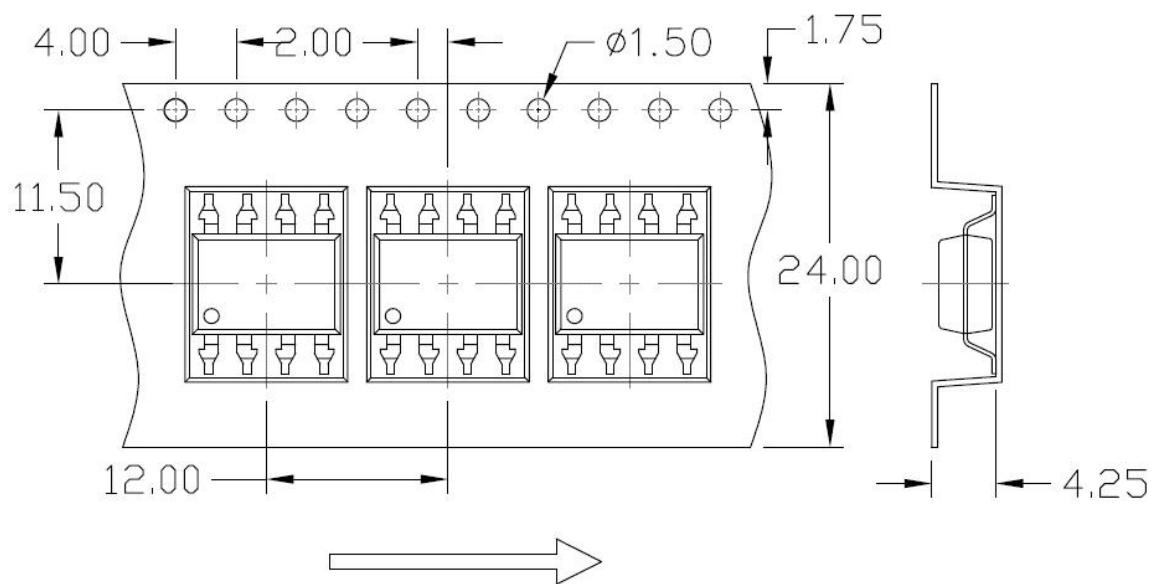
Carrier Tape Specifications (Dimensions in mm unless otherwise stated)**Option S(T1) & SL(T1)****Option S(T2) & SL(T2)**

Carrier Tape Specifications (Dimensions in mm unless otherwise stated)

Option SLM(T1)

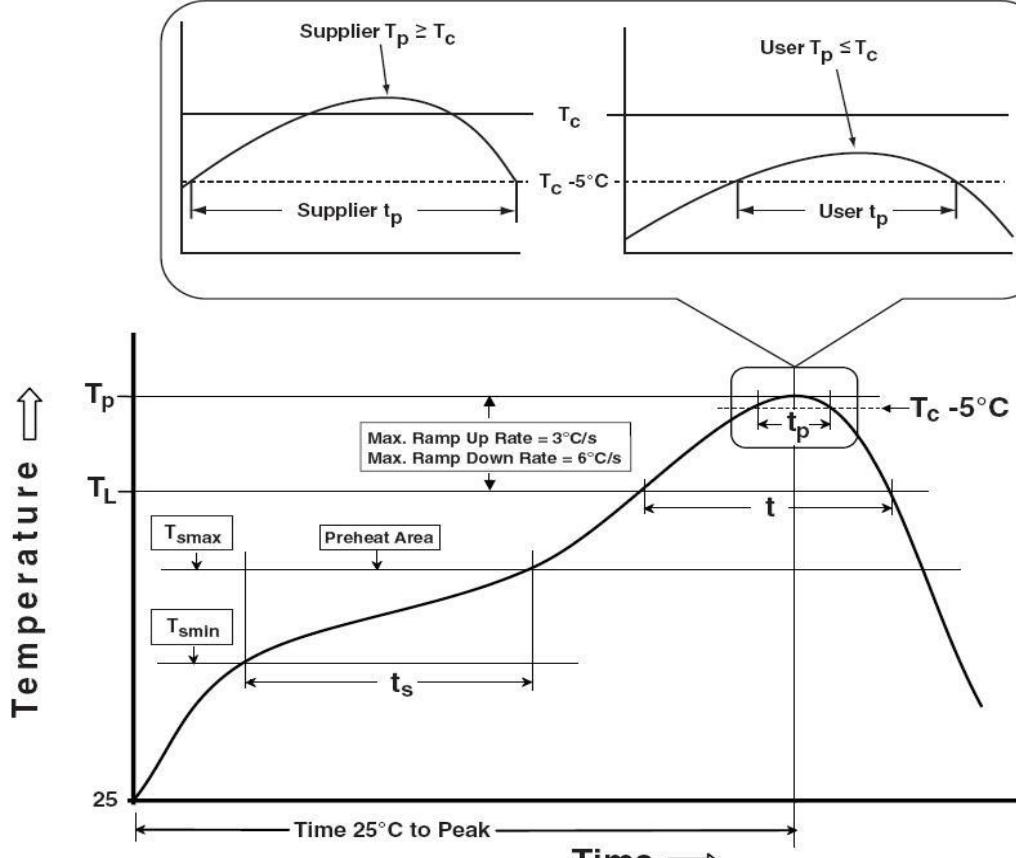


Option SLM(T2)



REFLOW INFORMATION

REFLOW PROFILE



IPC-020d-5-1

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150°C
Temperature Max. (T_{smax})	150	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_p)	3°C/second max.	3°C/second max.
Liquidous Temperature (T_L)	183°C	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t_p) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T_p to T_L)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.